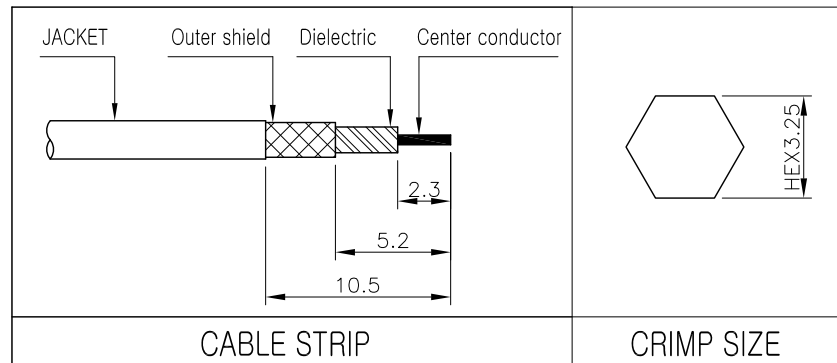
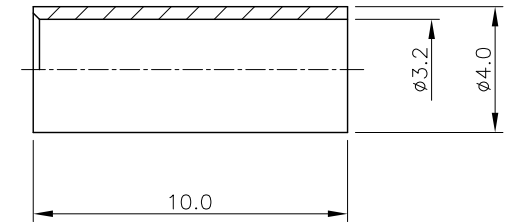
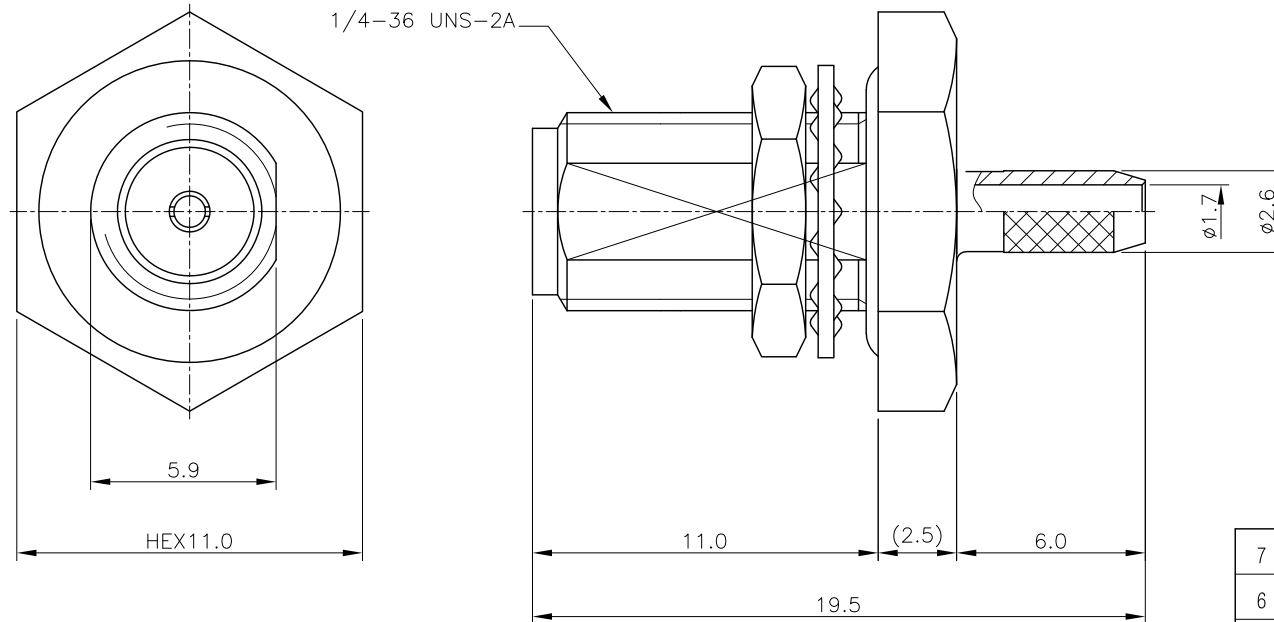


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
1R	Initial Registration	S.H.KIM		2025.01.17.



7	WASHER	1	BSS	Gold Plate	DWA00005-5/1
6	NUT	1	MBsBD C3604BD-F	Gold Plate	DNT00025-5/1
5	INSULATOR	1	TEFLON		DIN00172-N/1
4	GASKET	1	SILICONE RUB		DGK00023-N/1
3	FERRULE	1	MBsBD C3604BD-F	Nickel Plate	DFE00034-5/1
2	CONTACT	1	BeCu C17300	Gold Plate (1.27 μ m Min.)	DCT00143-5/2
1	BODY	1	MBsBD C3604BD-F	Gold Plate (0.508 μ m Min.)	DBD00172-5/4
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.2	DATE 2025. 01. 17.		 KJ COMTECH CO.,LTD.	RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017	
	Angle ±1°	APPROVED BY				
MATERIAL —		CHECKED BY		TITLE SMA50 CABLE JB (F/N) RG316		
		DRAWN BY	S.H.KIM			
FINISH —	SCALE 4/1	UNIT mm		A4	DWG NO. CN01034-7/6	SHEET 1 of 1
					REVISION I R	